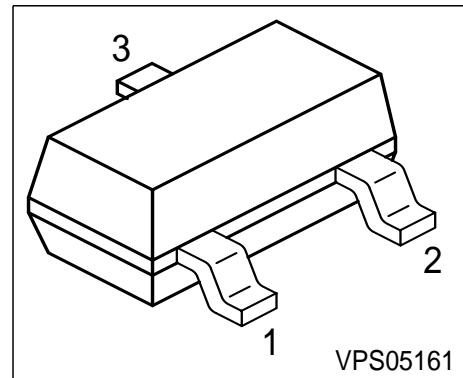


NPN Silicon Switching Transistors

- High DC current gain: 0.1mA to 500 mA
- Low collector-emitter saturation voltage
- Complementary types: BSS80, BSS82 (PNP)



Type	Marking	Pin Configuration			Package
BSS79B	CEs	1 = B	2 = E	3 = C	SOT23
BSS79C	CFs	1 = B	2 = E	3 = C	SOT23
BSS81B	CDs	1 = B	2 = E	3 = C	SOT23
BSS81C	CGs	1 = B	2 = E	3 = C	SOT23

Maximum Ratings

Parameter	Symbol	BSS79	BSS81	Unit
Collector-emitter voltage	V_{CEO}	40	35	V
Collector-base voltage	V_{CBO}	75		V
Emitter-base voltage	V_{EBO}	6		
DC collector current	I_C	800		mA
Peak collector current	I_{CM}	1		A
Base current	I_B	100		mA
Peak base current	I_{BM}	200		
Total power dissipation, $T_S = 77^\circ\text{C}$	P_{tot}	330		mW
Junction temperature	T_j	150		$^\circ\text{C}$
Storage temperature	T_{stg}	-65 ... 150		

Thermal Resistance

Junction - soldering point ¹⁾	R_{thJS}	≤ 220	K/W
--	------------	------------	-----

¹For calculation of R_{thJA} please refer to Application Note Thermal Resistance

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage $I_C = 10 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	40	-	-	V
		35	-	-	
Collector-base breakdown voltage $I_C = 10 \mu\text{A}, I_E = 0$	$V_{(\text{BR})\text{CBO}}$	75	-	-	
Emitter-base breakdown voltage $I_E = 10 \mu\text{A}, I_C = 0$	$V_{(\text{BR})\text{EBO}}$	6	-	-	
Collector cutoff current $V_{CB} = 60 \text{ V}, I_E = 0$	I_{CBO}	-	-	10	nA
Collector cutoff current $V_{CB} = 60 \text{ V}, I_E = 0, T_A = 150^\circ\text{C}$	I_{CBO}	-	-	10	µA
Emitter cutoff current $V_{EB} = 3 \text{ V}, I_C = 0$	I_{EBO}	-	-	10	nA
DC current gain 1) $I_C = 100 \mu\text{A}, V_{CE} = 10 \text{ V}$	h_{FE}	20	-	-	-
		35	-	-	
		25	-	-	
		50	-	-	
		35	-	-	
		75	-	-	
		40	-	120	
		100	-	300	
		25	-	-	
		40	-	-	
Collector-emitter saturation voltage1) $I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	V_{CEsat}	-	-	0.3	V
		-	-	1.3	
Base-emitter saturation voltage 1) $I_C = 150 \text{ mA}, I_B = 15 \text{ mA}$	V_{BEsat}	-	-	1.2	
		-	-	2.0	

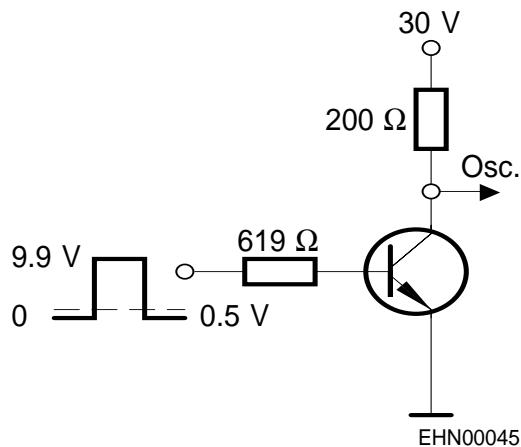
1) Pulse test: $t \leq 300 \mu\text{s}, D = 2\%$

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

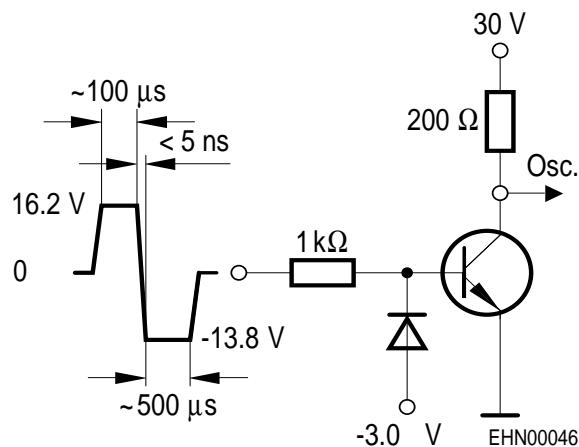
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics					
Transition frequency $I_C = 20 \text{ mA}, V_{CE} = 20 \text{ V}, f = 100 \text{ MHz}$	f_T	-	250	-	MHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{cb}	-	6	-	pF
Delay time $V_{CC} = 30 \text{ V}, I_C = 150 \text{ mA}, I_{B1} = 15 \text{ mA}, V_{BE(off)} = 0.5 \text{ V}$	t_d	-	-	10	ns
Rise time $V_{CC} = 30 \text{ V}, I_C = 150 \text{ mA}, I_{B1} = 15 \text{ mA}, V_{BE(off)} = 0.5 \text{ V}$	t_r	-	-	25	
Storage time $V_{CC} = 30 \text{ V}, I_C = 150 \text{ mA}, I_{B1}=I_{B2} = 15 \text{ mA}$	t_{sig}	-	-	250	
Fall time $V_{CC} = 30 \text{ V}, I_C = 150 \text{ mA}, I_{B1}=I_{B2} = 15 \text{ mA}$	t_f	-	-	60	

Test circuits

Delay and rise time



Storage and fall time

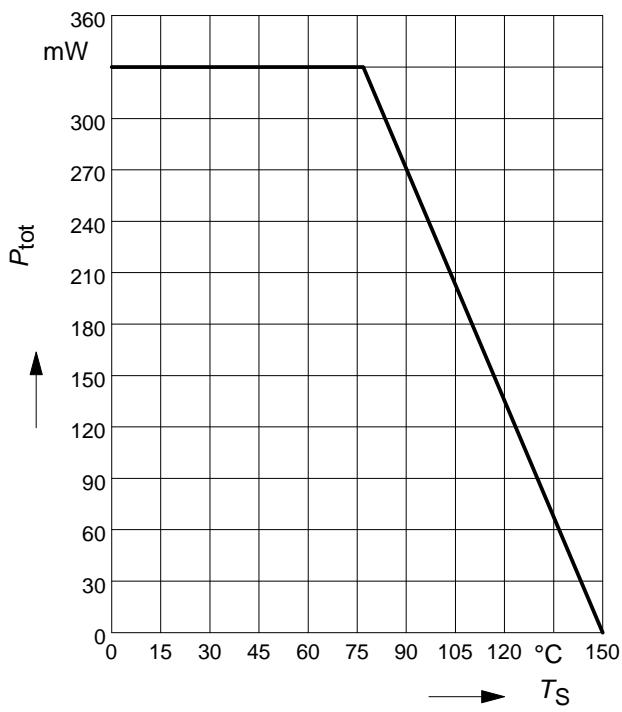


Oscillograph: $R > 100\text{k}\Omega$

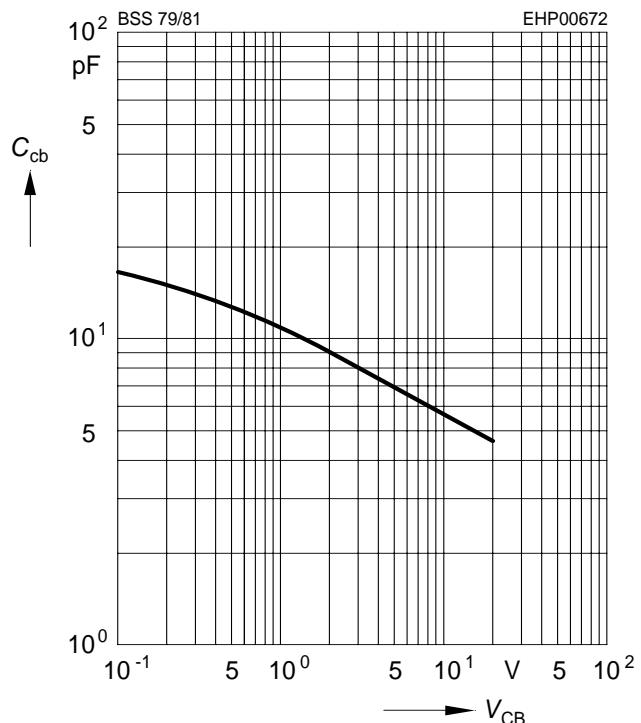
$C < 12\text{pF}$

$t_f < 5\text{ns}$

Total power dissipation $P_{\text{tot}} = f(T_S)$

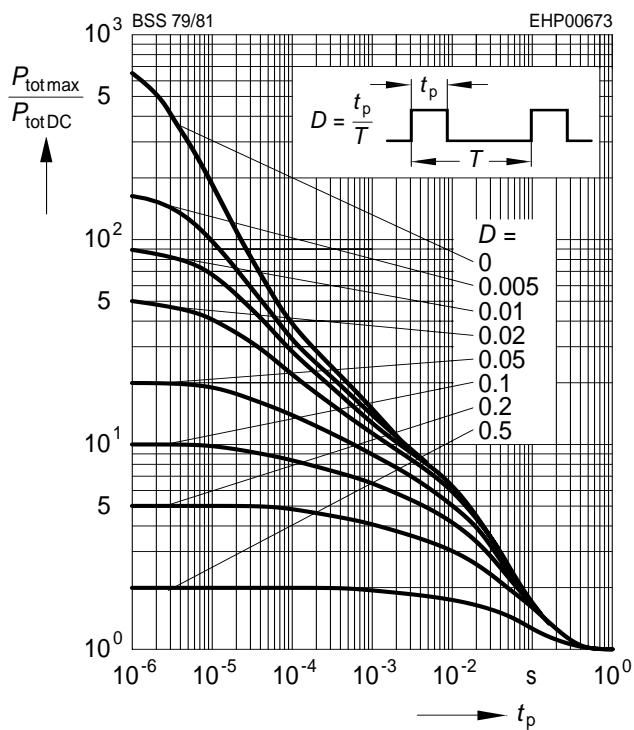


Collector-base capacitance $C_{CB} = f(V_{CB})$
 $f = 1\text{MHz}$



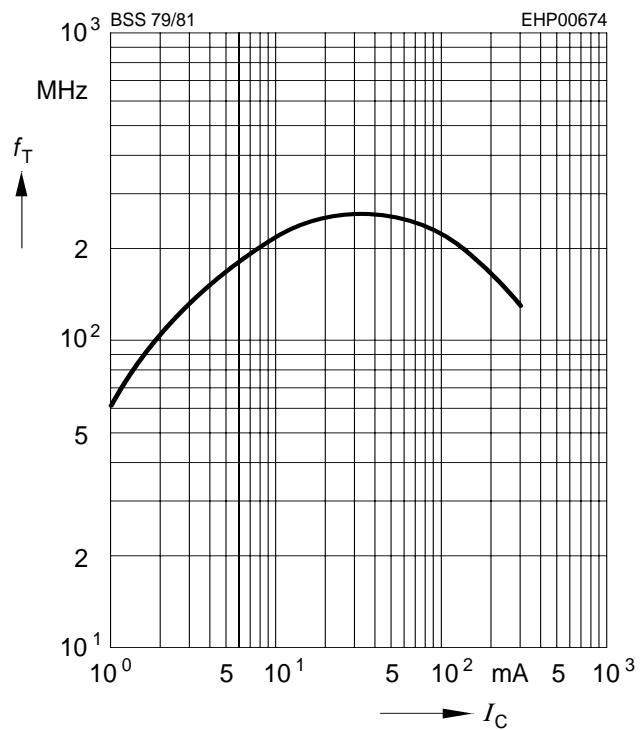
Permissible pulse load

$P_{\text{totmax}} / P_{\text{totDC}} = f(t_p)$

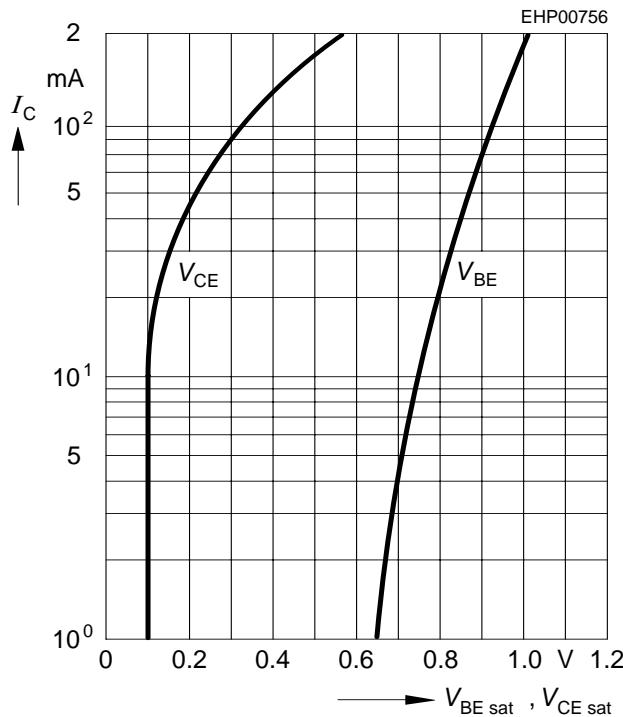


Transition frequency $f_T = f(I_C)$

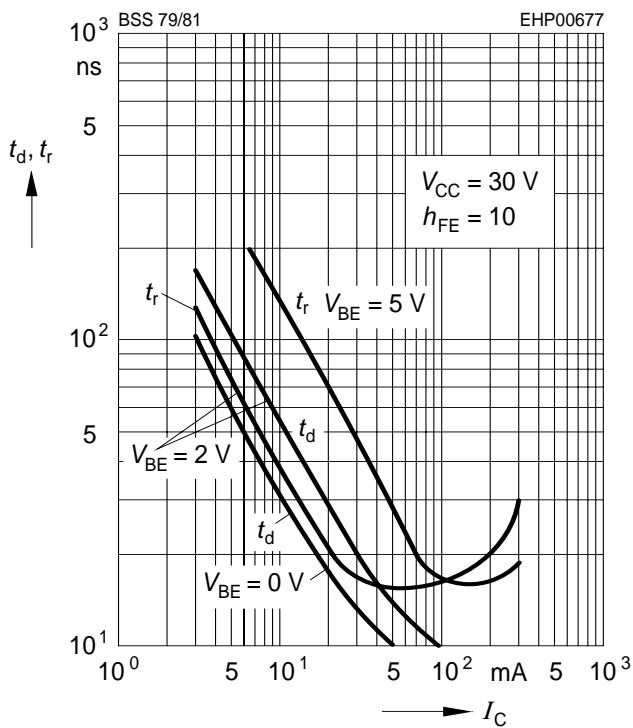
$V_{CE} = 20\text{V}$



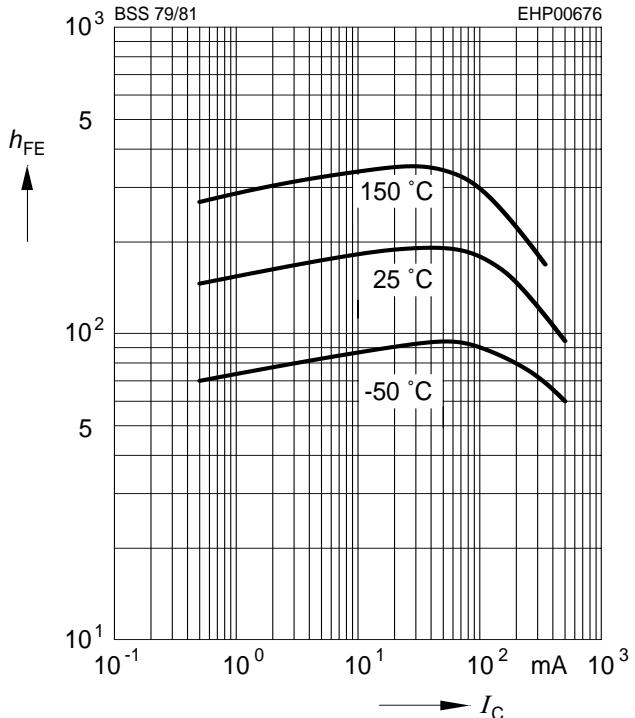
Saturation voltage $I_C = f(V_{BEsat}, V_{CEsat})$
 $h_{FE} = 10$



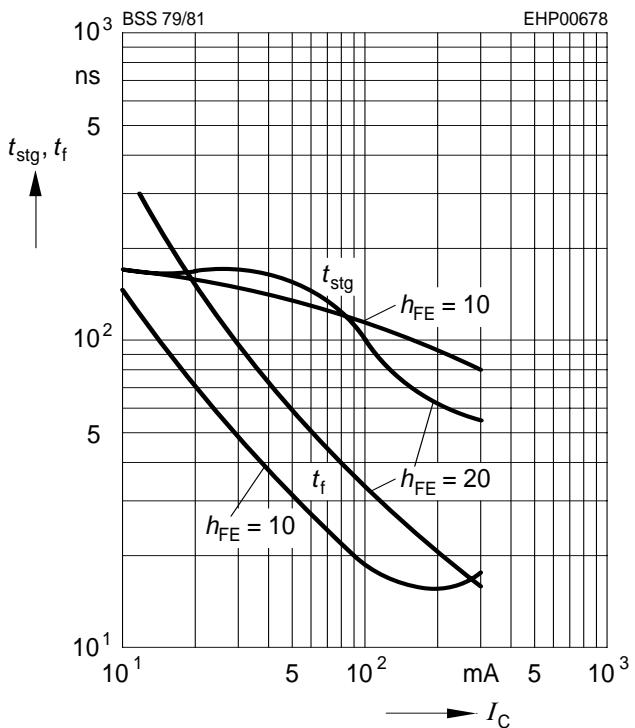
Delay time $t_d = f(I_C)$
Rise time $t_r = f(I_C)$



DC current gain $h_{FE} = f(I_C)$
 $V_{CE} = 10V$



Storage time $t_{stg} = f(I_C)$
Fall time $t_f = f(I_C)$



**Published by Infineon Technologies AG,
St.-Martin-Strasse 53,
81669 München**

**© Infineon Technologies AG 2004.
All Rights Reserved.**

Attention please!

The information herein is given to describe certain components and shall not be considered as a guarantee of characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.Infineon.com).

Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.